

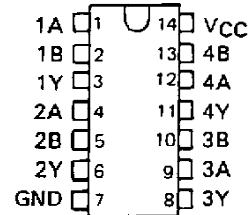
SDLS034

# QUADRUPLE 2-INPUT POSITIVE-AND GATES WITH OPEN-COLLECTOR OUTPUTS

SN5409, SN54LS09, SN54S09,  
SN7409, SN74LS09, SN74S09  
DECEMBER 1983—REVISED MARCH 1988

- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

SN5409, SN54LS09, SN54S09 . . . J OR W PACKAGE  
SN7409 . . . N PACKAGE  
SN74LS09, SN74S09 . . . D OR N PACKAGE  
(TOP VIEW)

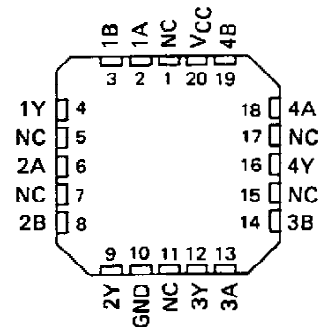


**description**

These devices contain four independent 2-input AND gates. The open-collector outputs require pull-up resistors to perform correctly. They may be connected to other open-collector outputs to implement active-low wired-OR or active-high wired-AND functions. Open-collector devices are often used to generate higher  $V_{OH}$  levels.

The SN5409, SN54LS09, and SN54S09 are characterized for operation over the full military temperature range of  $-55^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ . The SN7409, SN74LS09, and SN74S09 are characterized for operation from  $0^{\circ}\text{C}$  to  $70^{\circ}\text{C}$ .

SN54LS09, SN54S09 . . . FK PACKAGE  
(TOP VIEW)

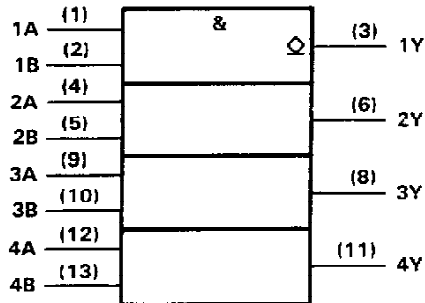


**FUNCTION TABLE (each gate)**

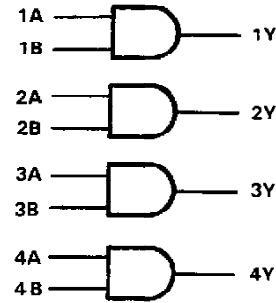
| INPUTS |   | OUTPUT |
|--------|---|--------|
| A      | B | Y      |
| H      | H | H      |
| L      | X | L      |
| X      | L | L      |

NC—No internal connection

**logic symbol**



**logic diagram (positive logic)**



$$Y = A \cdot B \text{ or } Y = \overline{\overline{A} + \overline{B}}$$

† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

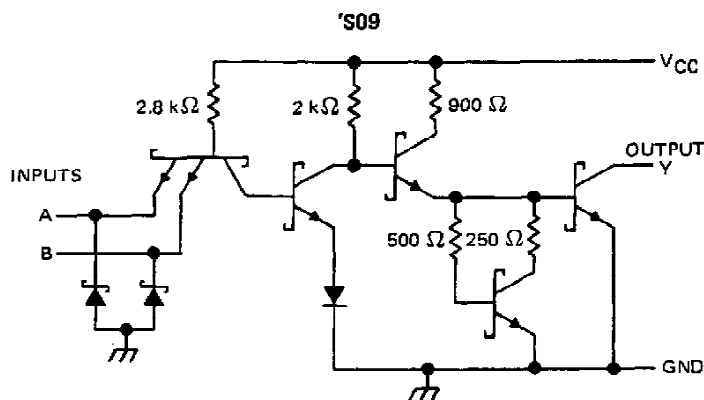
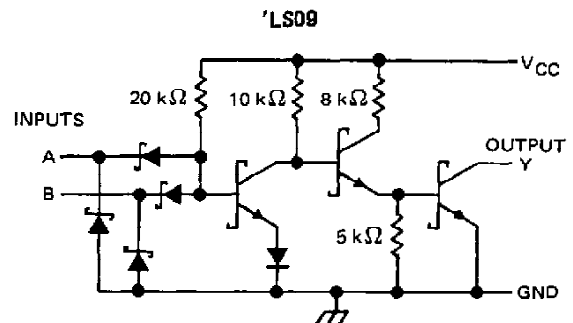
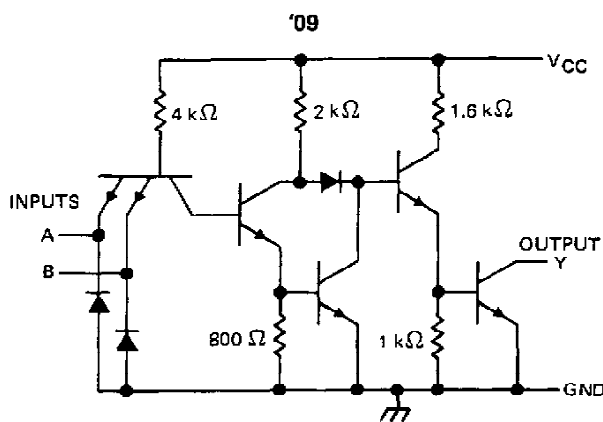
**PRODUCTION DATA** documents contain information current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



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**SN5409, SN54LS09, SN54S09,  
SN7409, SN74LS09, SN74S09  
QUADRUPLE 2-INPUT POSITIVE-AND GATES WITH OPEN-COLLECTOR OUTPUTS**

schematics (each gate)



Resistor values shown are nominal.

**absolute maximum ratings over operating free-air temperature range (unless otherwise noted)**

|   |                |
|---|----------------|
| Supply voltage, $V_{CC}$ (see Note 1)       | 7 V            |
| Input voltage: '09, 'S09                    | 5.5 V          |
| 'LS09                                       | 7 V            |
| Off-state output voltage                    | 7 V            |
| Operating free-air temperature range: SN54' | -55°C to 125°C |
| SN74'                                       | 0°C to 70°C    |
| Storage temperature range                   | -65°C to 150°C |

NOTE 1: Voltage values are with respect to network ground terminal.

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**SN5409, SN7409**  
**QUADRUPLE 2-INPUT POSITIVE-AND GATES WITH OPEN-COLLECTOR OUTPUTS**

**recommended operating conditions**

|                                      | SN5409 |     |     | SN7409 |     |      | UNIT |
|--------------------------------------|--------|-----|-----|--------|-----|------|------|
|                                      | MIN    | NOM | MAX | MIN    | NOM | MAX  |      |
| $V_{CC}$ Supply voltage              | 4.5    | 5   | 5.5 | 4.75   | 5   | 5.25 | V    |
| $V_{IH}$ High-level input voltage    | 2      |     |     | 2      |     |      | V    |
| $V_{IL}$ Low-level input voltage     |        |     | 0.8 |        |     | 0.8  | V    |
| $V_{OH}$ High-level output voltage   |        |     | 5.5 |        |     | 5.5  | V    |
| $I_{OL}$ Low-level output current    |        |     | 16  |        |     | 16   | mA   |
| $T_A$ Operating free-air temperature | -55    |     | 125 | 0      |     | 70   | °C   |

**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

| PARAMETER | TEST CONDITIONS†  | MIN | TYP‡ | MAX  | UNIT |
|-----------|---|-----|------|------|------|
| $V_{IK}$  | $V_{CC} = \text{MIN}$ , $I_I = -12 \text{ mA}$                              |     |      | -1.5 | V    |
| $I_{OH}$  | $V_{CC} = \text{MIN}$ , $V_{IH} = 2 \text{ V}$ , $V_{OH} = 5.5 \text{ V}$   |     |      | 0.25 | mA   |
| $V_{OL}$  | $V_{CC} = \text{MIN}$ , $V_{IL} = 0.8 \text{ V}$ , $I_{OL} = 16 \text{ mA}$ |     | 0.2  | 0.4  | V    |
| $I_I$     | $V_{CC} = \text{MAX}$ , $V_I = 5.5 \text{ V}$                               |     |      | 1    | mA   |
| $I_{IH}$  | $V_{CC} = \text{MAX}$ , $V_I = 2.4 \text{ V}$                               |     |      | 40   | μA   |
| $I_{IL}$  | $V_{CC} = \text{MAX}$ , $V_I = 0.4 \text{ V}$                               |     |      | -1.6 | mA   |
| $I_{CCH}$ | $V_{CC} = \text{MAX}$ , $V_I = 4.5 \text{ V}$                               |     | 11   | 21   | mA   |
| $I_{CCL}$ | $V_{CC} = \text{MAX}$ , $V_I = 0 \text{ V}$                                 |     | 20   | 33   | mA   |

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡ All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^\circ\text{C}$ .

**switching characteristics,  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^\circ\text{C}$  (see note 2)**

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | TEST CONDITIONS                            | MIN | TYP | MAX | UNIT |
|-----------|--------------|-------------|--|-----|-----|-----|------|
| $t_{PLH}$ | A or B       | Y           | $R_L = 400 \Omega$ , $C_L = 15 \text{ pF}$ |     | 21  | 32  | ns   |
| $t_{PHL}$ |              |             |  |     | 16  | 24  | ns   |

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.



# SN54LS09, SN74LS09 QUADRUPLE 2-INPUT POSITIVE-AND GATES WITH OPEN-COLLECTOR OUTPUTS

## recommended operating conditions

|   | SN54LS09 |     |     | SN74LS09 |     |      | UNIT |
|---|----------|-----|-----|----------|-----|------|------|
|   | MIN      | NOM | MAX | MIN      | NOM | MAX  |      |
| V <sub>CC</sub> Supply voltage                | 4.5      | 5   | 5.5 | 4.75     | 5   | 5.25 | V    |
| V <sub>IH</sub> High-level input voltage      | 2        |     |     | 2        |     |      | V    |
| V <sub>IL</sub> Low-level input voltage       |          |     | 0.7 |          |     | 0.8  | V    |
| V <sub>OH</sub> High-level output voltage     |          |     | 5.5 |          |     | 5.5  | V    |
| I <sub>OL</sub> Low-level output current      |          |     | 4   |          |     | 8    | mA   |
| T <sub>A</sub> Operating free-air temperature | -55      |     | 125 | 0        |     | 70   | °C   |

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER        | TEST CONDITIONS†  | SN54LS09 |      |      | SN74LS09 |      |      | UNIT |
|------------------|---|----------|------|------|----------|------|------|------|
|                  |   | MIN      | TYP‡ | MAX  | MIN      | TYP‡ | MAX  |      |
| V <sub>IK</sub>  | V <sub>CC</sub> = MIN, I <sub>I</sub> = -18 mA                        |          |      | -1.5 |          |      | -1.5 | V    |
| I <sub>OH</sub>  | V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V, V <sub>OH</sub> = 5.5 V |          |      | 0.1  |          |      | 0.1  | mA   |
| V <sub>OL</sub>  | V <sub>CC</sub> = MIN, V <sub>IL</sub> = MAX, I <sub>OL</sub> = 4 mA  |          | 0.25 | 0.4  |          | 0.25 | 0.4  | V    |
|                  | V <sub>CC</sub> = MIN, V <sub>IL</sub> = MAX, I <sub>OL</sub> = 8 mA  |          |      |      |          | 0.35 | 0.5  |      |
| I <sub>I</sub>   | V <sub>CC</sub> = MAX, V <sub>I</sub> = 7 V                           |          |      | 0.1  |          |      | 0.1  | mA   |
| I <sub>IH</sub>  | V <sub>CC</sub> = MAX, V <sub>I</sub> = 2.7 V                         |          |      | 20   |          |      | 20   | μA   |
| I <sub>IL</sub>  | V <sub>CC</sub> = MAX, V <sub>I</sub> = 0.4 V                         |          |      | -0.4 |          |      | -0.4 | mA   |
| I <sub>CCH</sub> | V <sub>CC</sub> = MAX, V <sub>I</sub> = 4.5 V                         |          | 2.4  | 4.8  |          | 2.4  | 4.8  | mA   |
| I <sub>CCL</sub> | V <sub>CC</sub> = MAX, V <sub>I</sub> = 0 V                           |          | 4.4  | 8.8  |          | 4.4  | 8.8  | mA   |

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡ All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C.

## switching characteristics, V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C (see note 2)

| PARAMETER        | FROM (INPUT) | TO (OUTPUT) | TEST CONDITIONS                               | MIN | TYP | MAX | UNIT |
|------------------|--------------|-------------|---|-----|-----|-----|------|
| t <sub>PLH</sub> | A or B       | Y           | R <sub>L</sub> = 2 kΩ, C <sub>L</sub> = 15 pF |     | 20  | 35  | ns   |
| t <sub>PHL</sub> |              |             |   |     | 17  | 35  | ns   |

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

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**SN54S09, SN74S09**  
**QUADRUPLE 2-INPUT POSITIVE-AND GATES WITH OPEN-COLLECTOR OUTPUTS**

**recommended operating conditions**

|   | SN54S09 |     |     | SN74S09 |     |      | UNIT |
|---|---------|-----|-----|---------|-----|------|------|
|   | MIN     | NOM | MAX | MIN     | NOM | MAX  |      |
| V <sub>CC</sub> Supply voltage                | 4.5     | 5   | 5.5 | 4.75    | 5   | 5.25 | V    |
| V <sub>IH</sub> High-level input voltage      | 2       |     |     | 2       |     |      | V    |
| V <sub>IL</sub> Low-level input voltage       |         |     | 0.8 |         |     | 0.8  | V    |
| V <sub>OH</sub> High-level output voltage     |         |     | 5.5 |         |     | 5.5  | V    |
| I <sub>OL</sub> Low-level output current      |         |     | 20  |         |     | 20   | mA   |
| T <sub>A</sub> Operating free-air temperature | -55     |     | 125 | 0       |     | 70   | °C   |

**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

| PARAMETER        | TEST CONDITIONS†  | MIN | TYP‡ | MAX  | UNIT |    |
|------------------|---|-----|------|------|------|----|
| V <sub>IK</sub>  | V <sub>CC</sub> = MIN, I <sub>I</sub> = -18 mA                          |     |      | -1.2 | V    |    |
| I <sub>OH</sub>  | V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V, V <sub>OH</sub> = 5.5 V   |     |      | 0.25 | mA   |    |
| V <sub>OL</sub>  | V <sub>CC</sub> = MIN, V <sub>IL</sub> = 0.8 V, I <sub>OL</sub> = 20 mA |     |      | 0.5  | V    |    |
| I <sub>I</sub>   | V <sub>CC</sub> = MAX, V <sub>I</sub> = 5.5 V                           |     |      | 1    | mA   |    |
| I <sub>IH</sub>  | V <sub>CC</sub> = MAX, V <sub>I</sub> = 2.7 V                           |     |      | 50   | μA   |    |
| I <sub>IL</sub>  | V <sub>CC</sub> = MAX, V <sub>I</sub> = 0.5 V                           |     |      | -2   | mA   |    |
| I <sub>CCH</sub> | V <sub>CC</sub> = MAX, V <sub>I</sub> = 4.5 V                           |     |      | 18   | 32   | mA |
| I <sub>CCL</sub> | V <sub>CC</sub> = MAX, V <sub>I</sub> = 0 V                             |     |      | 32   | 57   | mA |

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡ All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C.

**switching characteristics, V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C (see note 2)**

| PARAMETER        | FROM (INPUT) | TO (OUTPUT) | TEST CONDITIONS                                | MIN | TYP | MAX | UNIT |
|------------------|--------------|-------------|--|-----|-----|-----|------|
| t <sub>PLH</sub> | A or B       | Y           | R <sub>L</sub> = 280 Ω, C <sub>L</sub> = 15 pF | 6.5 | 10  | ns  |      |
| t <sub>PHL</sub> |              |             |  | 6.5 | 10  | ns  |      |
| t <sub>PLH</sub> |              |             | R <sub>L</sub> = 280 Ω, C <sub>L</sub> = 50 pF | 9   | ns  |     |      |
| t <sub>PHL</sub> |              |             |  | 9   | ns  |     |      |

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.



**PACKAGING INFORMATION**

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| 80019012A        | ACTIVE                | LCCC         | FK              | 20   | 1           | TBD                     | POST-PLATE       | N / A for Pkg Type           |
| 8001901CA        | ACTIVE                | CDIP         | J               | 14   | 1           | TBD                     | A42              | N / A for Pkg Type           |
| 8001901CA        | ACTIVE                | CDIP         | J               | 14   | 1           | TBD                     | A42              | N / A for Pkg Type           |
| 8001901DA        | ACTIVE                | CFP          | W               | 14   | 1           | TBD                     | A42              | N / A for Pkg Type           |
| 8001901DA        | ACTIVE                | CFP          | W               | 14   | 1           | TBD                     | A42              | N / A for Pkg Type           |
| SN54LS09J        | ACTIVE                | CDIP         | J               | 14   | 1           | TBD                     | A42              | N / A for Pkg Type           |
| SN54LS09J        | ACTIVE                | CDIP         | J               | 14   | 1           | TBD                     | A42              | N / A for Pkg Type           |
| SN54S09J         | ACTIVE                | CDIP         | J               | 14   | 1           | TBD                     | A42              | N / A for Pkg Type           |
| SN54S09J         | ACTIVE                | CDIP         | J               | 14   | 1           | TBD                     | A42              | N / A for Pkg Type           |
| SN7409N          | OBSOLETE              | PDIP         | N               | 14   |             | TBD                     | Call TI          | Call TI                      |
| SN7409N          | OBSOLETE              | PDIP         | N               | 14   |             | TBD                     | Call TI          | Call TI                      |
| SN74LS09D        | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LS09D        | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LS09DE4      | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LS09DE4      | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LS09DG4      | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LS09DG4      | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LS09DR       | ACTIVE                | SOIC         | D               | 14   | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LS09DR       | ACTIVE                | SOIC         | D               | 14   | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LS09DRE4     | ACTIVE                | SOIC         | D               | 14   | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LS09DRE4     | ACTIVE                | SOIC         | D               | 14   | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LS09DRG4     | ACTIVE                | SOIC         | D               | 14   | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LS09DRG4     | ACTIVE                | SOIC         | D               | 14   | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LS09J        | OBSOLETE              | CDIP         | J               | 14   |             | TBD                     | Call TI          | Call TI                      |
| SN74LS09J        | OBSOLETE              | CDIP         | J               | 14   |             | TBD                     | Call TI          | Call TI                      |
| SN74LS09N        | ACTIVE                | PDIP         | N               | 14   | 25          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| SN74LS09N        | ACTIVE                | PDIP         | N               | 14   | 25          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| SN74LS09N3       | OBSOLETE              | PDIP         | N               | 14   |             | TBD                     | Call TI          | Call TI                      |
| SN74LS09N3       | OBSOLETE              | PDIP         | N               | 14   |             | TBD                     | Call TI          | Call TI                      |
| SN74LS09NE4      | ACTIVE                | PDIP         | N               | 14   | 25          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| SN74LS09NE4      | ACTIVE                | PDIP         | N               | 14   | 25          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| SN74LS09NSR      | ACTIVE                | SO           | NS              | 14   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LS09NSR      | ACTIVE                | SO           | NS              | 14   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LS09NSRE4    | ACTIVE                | SO           | NS              | 14   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LS09NSRE4    | ACTIVE                | SO           | NS              | 14   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LS09NSRG4    | ACTIVE                | SO           | NS              | 14   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74LS09NSRG4    | ACTIVE                | SO           | NS              | 14   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74S09D         | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74S09D         | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74S09DE4       | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74S09DE4       | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74S09DG4       | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74S09DG4       | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74S09N         | ACTIVE                | PDIP         | N               | 14   | 25          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| SN74S09N         | ACTIVE                | PDIP         | N               | 14   | 25          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| SN74S09NE4       | ACTIVE                | PDIP         | N               | 14   | 25          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| SN74S09NE4       | ACTIVE                | PDIP         | N               | 14   | 25          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| SN74S09NSR       | ACTIVE                | SO           | NS              | 14   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74S09NSR       | ACTIVE                | SO           | NS              | 14   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74S09NSRE4     | ACTIVE                | SO           | NS              | 14   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74S09NSRE4     | ACTIVE                | SO           | NS              | 14   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74S09NSRG4     | ACTIVE                | SO           | NS              | 14   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74S09NSRG4     | ACTIVE                | SO           | NS              | 14   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SNJ54LS09FK      | ACTIVE                | LCCC         | FK              | 20   | 1           | TBD                     | POST-PLATE       | N / A for Pkg Type           |
| SNJ54LS09FK      | ACTIVE                | LCCC         | FK              | 20   | 1           | TBD                     | POST-PLATE       | N / A for Pkg Type           |
| SNJ54LS09J       | ACTIVE                | CDIP         | J               | 14   | 1           | TBD                     | A42              | N / A for Pkg Type           |
| SNJ54LS09J       | ACTIVE                | CDIP         | J               | 14   | 1           | TBD                     | A42              | N / A for Pkg Type           |
| SNJ54LS09W       | ACTIVE                | CFP          | W               | 14   | 1           | TBD                     | A42              | N / A for Pkg Type           |
| SNJ54LS09W       | ACTIVE                | CFP          | W               | 14   | 1           | TBD                     | A42              | N / A for Pkg Type           |

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| SNJ54S09FK       | ACTIVE                | LCCC         | FK              | 20   | 1           | TBD                     | POST-PLATE       | N / A for Pkg Type           |
| SNJ54S09FK       | ACTIVE                | LCCC         | FK              | 20   | 1           | TBD                     | POST-PLATE       | N / A for Pkg Type           |
| SNJ54S09J        | ACTIVE                | CDIP         | J               | 14   | 1           | TBD                     | A42              | N / A for Pkg Type           |
| SNJ54S09J        | ACTIVE                | CDIP         | J               | 14   | 1           | TBD                     | A42              | N / A for Pkg Type           |
| SNJ54S09W        | ACTIVE                | CFP          | W               | 14   | 1           | TBD                     | A42              | N / A for Pkg Type           |
| SNJ54S09W        | ACTIVE                | CFP          | W               | 14   | 1           | TBD                     | A42              | N / A for Pkg Type           |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSELETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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**TAPE AND REEL INFORMATION**

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**


\*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74LS09DR  | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| SN74LS09NSR | SO           | NS              | 14   | 2000 | 330.0              | 16.4               | 8.2     | 10.5    | 2.5     | 12.0    | 16.0   | Q1            |
| SN74S09NSR  | SO           | NS              | 14   | 2000 | 330.0              | 16.4               | 8.2     | 10.5    | 2.5     | 12.0    | 16.0   | Q1            |

**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74LS09DR  | SOIC         | D               | 14   | 2500 | 346.0       | 346.0      | 33.0        |
| SN74LS09NSR | SO           | NS              | 14   | 2000 | 346.0       | 346.0      | 33.0        |
| SN74S09NSR  | SO           | NS              | 14   | 2000 | 346.0       | 346.0      | 33.0        |

J (R-GDIP-T\*\*)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



| DIM \ PINS ** | 14                     | 16                     | 18                     | 20                     |
|---------------|------------------------|------------------------|------------------------|------------------------|
| A             | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC |
| B MAX         | 0.785<br>(19,94)       | .840<br>(21,34)        | 0.960<br>(24,38)       | 1.060<br>(26,92)       |
| B MIN         | —                      | —                      | —                      | —                      |
| C MAX         | 0.300<br>(7,62)        | 0.300<br>(7,62)        | 0.310<br>(7,87)        | 0.300<br>(7,62)        |
| C MIN         | 0.245<br>(6,22)        | 0.245<br>(6,22)        | 0.220<br>(5,59)        | 0.245<br>(6,22)        |



4040083/F 03/03

- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - This package is hermetically sealed with a ceramic lid using glass frit.
  - Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
  - Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F14)

CERAMIC DUAL FLATPACK



4040180-2/D 07/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package can be hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only.
  - E. Falls within MIL STD 1835 GDFP1-F14 and JEDEC MO-092AB

FK (S-CQCC-N\*\*)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



| NO. OF TERMINALS ** | A                |                  | B                |                  |
|---------------------|------------------|------------------|------------------|------------------|
|                     | MIN              | MAX              | MIN              | MAX              |
| 20                  | 0.342<br>(8,69)  | 0.358<br>(9,09)  | 0.307<br>(7,80)  | 0.358<br>(9,09)  |
| 28                  | 0.442<br>(11,23) | 0.458<br>(11,63) | 0.406<br>(10,31) | 0.458<br>(11,63) |
| 44                  | 0.640<br>(16,26) | 0.660<br>(16,76) | 0.495<br>(12,58) | 0.560<br>(14,22) |
| 52                  | 0.740<br>(18,78) | 0.761<br>(19,32) | 0.495<br>(12,58) | 0.560<br>(14,22) |
| 68                  | 0.938<br>(23,83) | 0.962<br>(24,43) | 0.850<br>(21,6)  | 0.858<br>(21,8)  |
| 84                  | 1.141<br>(28,99) | 1.165<br>(29,59) | 1.047<br>(26,6)  | 1.063<br>(27,0)  |



4040140/D 01/11

- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - This package can be hermetically sealed with a metal lid.
  - Falls within JEDEC MS-004

N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
  - The 20 pin end lead shoulder width is a vendor option, either half or full width.

D (R-PDSO-G14)

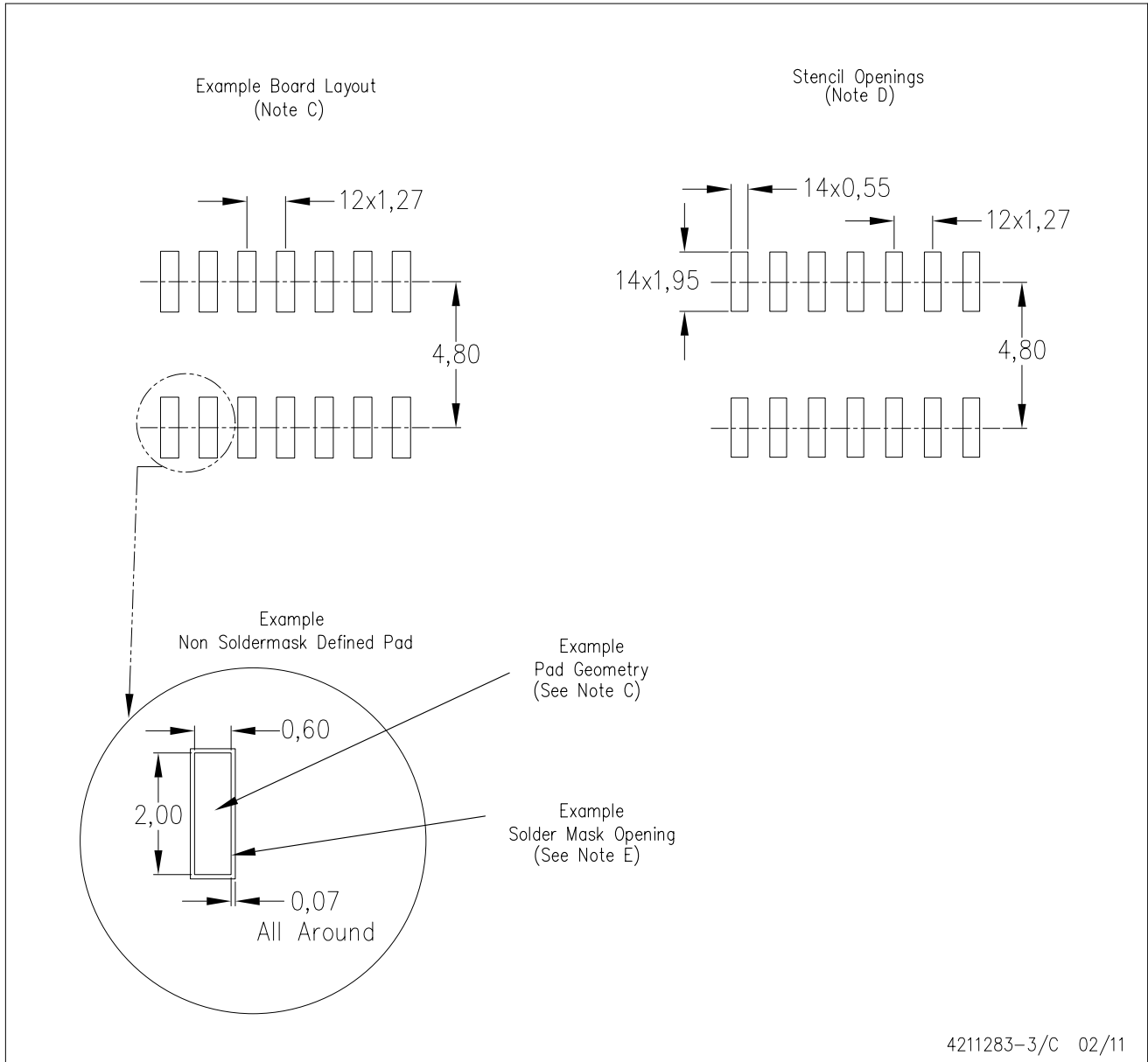
PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
  - D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
  - E. Reference JEDEC MS-012 variation AB.

D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Publication IPC-7351 is recommended for alternate designs.
  - Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



## MECHANICAL DATA

NS (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

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